

XI'AN IR-PERI
Company

Fast Recovery Epitaxial Diode INT-A -PAK

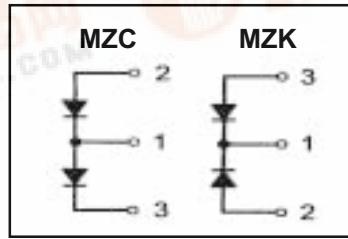
PRELIMINARY

MZC400TS60U
MZK400TS60U

Ultra-Fast™ Speed FRED

Features

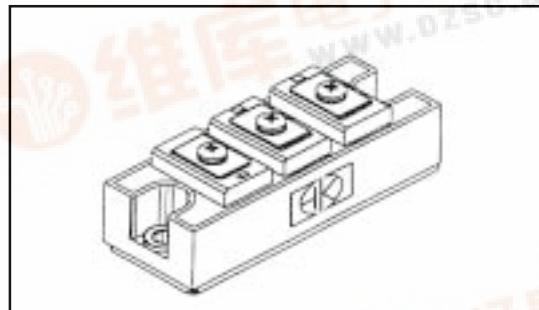
- International standard package
- With DBC ceramic base plate
- Planar passivated chips
- Short recovery time
- Low switching losses
- Ultra-soft recovery behaviour
- Industry standard package
- UL recognition pending



V_{RRM} = 600V
I_{FAVM} = 400A
t_{rr} = 250ns

Benefits

- Antiparallel diode for high frequency switching devices
- Increased operating efficiency
- Direct mounting to heatsink
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders
- Low voltage peaks for reduced protection circuits



Absolute Maximum Ratings

| Symbol | Test Conditions | Max. | Units |
|-------------------------------------|--|-------------|------------------|
| V _{RSM} & V _{RRM} | | 600 | V |
| I _{FRMS} | T _c =75 °C | 560 | A |
| I _{FAVM} | T _c =75°C; rectangular, d=0.5 | 400 | A |
| I _{FRM} | t _p <10μs; rep. rating, pulse width limited by T _{VJM} | 2185 | A |
| I _{FSM} | T _{VJ} =45 °C; t=10ms (50 Hz),sine t=8.3ms (60 Hz),sine | 3300 | A |
| | | 3600 | A |
| I _{FSM} | T _{VJ} =150 °C; t=10ms (50 Hz),sine t=8.3ms (60 Hz),sine | 2880 | A |
| | | 3180 | A |
| I ² t | T _{VJ} =45 °C; t=10ms (50 Hz),sine t=8.3ms (60 Hz),sine | 38400 | A ² s |
| | | 39100 | A ² s |
| I ² t | T _{VJ} =150 °C; t=10ms (50 Hz),sine t=8.3ms (60 Hz),sine | 31100 | A ² s |
| | | 31800 | A ² s |
| V _{SOL} | RMS Isolation Voltage, Any Terminal To Case, t=1 min | 2500 | V |
| P _D | T _c =25 °C | 1008 | W |
| T _J | Operating Junction Temperature Range | -40 to +150 | °C |
| T _{STG} | Storage Temperature Range | -40 to +125 | |

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Termal / Mechanical Characteristics

| | Parameter | Typ. | Max. | Units |
|------------------|--|------|-------|-------|
| R _{θJS} | Termal Resistance, Junction-to- Sink DC | - | 0.202 | |
| R _{θJC} | Termal Resistance, Junction-to- Case DC | - | 0.122 | °C/W |
| R _{θCS} | Termal Resistance, Csar-to- Sink- Module | 0.08 | - | |
| | Mouting Torque, Case-to-Heatsink | - | 4.0 | N.m |
| | Mouting Torque, Case-to-Terminal 1,2 & 3 | - | 3.0 | |
| | Weight of Module | 200 | - | g |

Electrical Characteristics (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|---------------------------------------|----------------------------------|------|------|------|-------|---|
| V _{RRM} | Reverse Breakdown Voltage | 600 | - | - | V | I _R =16mA |
| I _R | Diode Leaking Current | - | - | 16 | mA | T _{VJ} =25 °C V _R =V _{RRM} |
| | | - | - | 5 | mA | T _{VJ} =25 °C V _R =0.8V _{RRM} |
| | | - | - | 100 | mA | T _{VJ} =125 °C V _R =0.8V _{RRM} |
| V _F | Diode Forward Voltage | - | - | 1.17 | V | I _f =230A; T _{VJ} =125 °C |
| | | - | - | 1.36 | V | T _{VJ} = 25 °C |
| | | - | - | 1.41 | V | I _f =400A; T _{VJ} =125 °C |
| | | - | - | 1.52 | V | T _{VJ} = 25 °C |
| V _{TO} | For power-loss calculations only | - | - | 0.85 | V | |
| r _T | | - | - | 1.14 | mΩ | |
| t _{rr@T_{VJ}=100 °C} | Diode Reverse Recovery Time | - | 250 | 300 | ns | I _f =400A |
| I _{RM@T_{VJ}= 25 °C} | Diode Peak Reverse Current | - | - | 66 | A | V _R =300V |
| I _{RM@T_{VJ}=100 °C} | Diode Peak Reverse Current | - | - | 110 | A | -di/dt=600A/μs |

Case Outline - Int-a-pak

